New Product

Vishay Siliconix

P-Channel 60-V (D-S) MOSFET

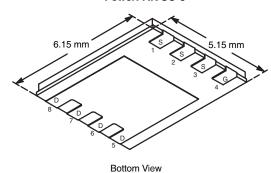
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	$OS(on)$ (Ω) $I_D(A)$ $Q_g(\overline{\ })$			
-60	0.064 @ V _{GS} = -10 V	- 5	26		
	0.080 @ V _{GS} = -4.5 V	-4.5	20		

FEATURES

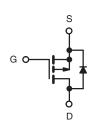
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile



PowerPAK SO-8



Ordering Information: Si7465DP-T1—E3 (Lead (Pb)-Free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$I_A = 25$ °C, unles	ss otnerwise r	notea		
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	-60		V
Gate-Source Voltage		V _{GS}	±20		V
Continuous Drain Current (T = 150°C)a	T _A = 25°C	I _D	- 5	-3.2	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C		-4	-2.6	
Pulsed Drain Current		I _{DM}	-25		Α
Continuous Source Current (Diode Conduction) ^a		I _S	-2.9	-1.2	
Avalanche Current	L = 0.1 mH	I _{AS}	22 24.2		
Single Pulse Avalanche Energy	L = 0.111111	E _{AS}			mJ
Mandanana Danana Disabaharia	T _A = 25°C	P _D	3.5	1.5	W
Maximum Power Dissipation ^a	T _A = 70°C	' D	2.2	0.94	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}		•	2	260	C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian de Ambienta	t ≤ 10 sec	R _{thJA}	27	36	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		60	85		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3.3	4.3		

Notes
a. Surface Mounted on 1" x 1" FR4 Board.
b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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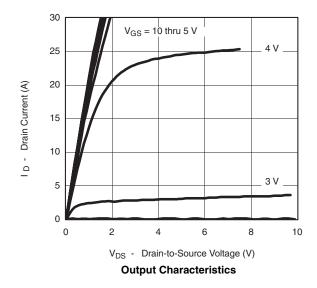
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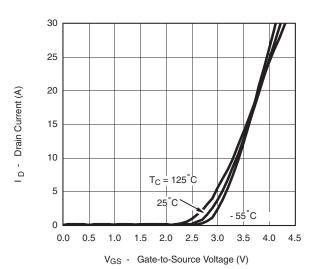


SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	-1.0		-3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA	
Zava Cata Valtaga Dvain Current	I _{DSS} _	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μА	
Zero Gate Voltage Drain Current		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$			-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-25			Α	
	_	$V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$		0.051	0.064	0	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -4.5 \text{ A}$		0.064	0.080	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -15 \text{ V}, I_{D} = -5 \text{ A}$		16		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			26	40		
Gate-Source Charge	Q _{gs} Q _{gd}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -5 \text{ A}$		4.5		nC	
Gate-Drain Charge				7.0			
Gate Resistance	R_{g}			7.0		Ω	
Turn-On Delay Time	t _{d(on)}			8	15		
Rise Time	t _r	$V_{DD} = -30 \text{ V}, R_L = 30 \Omega$		9	15		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1.0 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 6 \Omega$		65	100	ns	
Fall Time	t _f			30	45		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -5 A, di/dt = 100 A/μs		41	70		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted



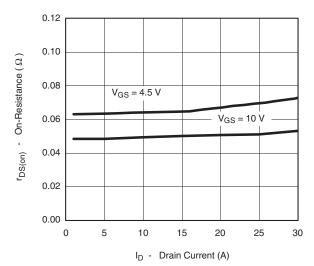


Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

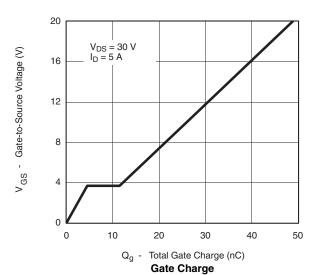


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TYPICAL CHARACTERISTICS 25 °C, unless noted



On-Resistance vs. Drain Current

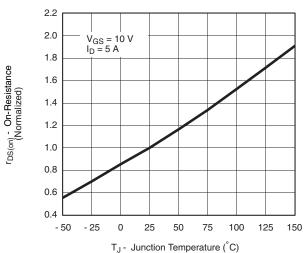


(4) T_J = 150°C T_J = 150°C T_J = 25°C T_J = 25°C

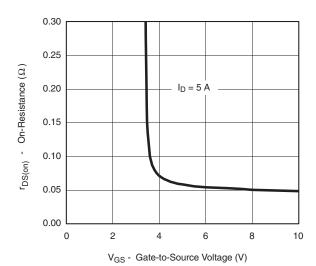
1800 1500 C_{iss} C - Capacitance (pF) 1200 900 600 300 0 0 10 20 30 50 60 40

V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature



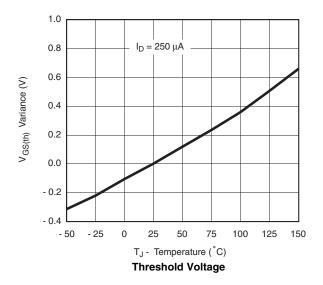
On-Resistance vs. Gate-to-Source Voltage

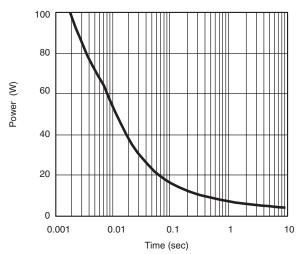
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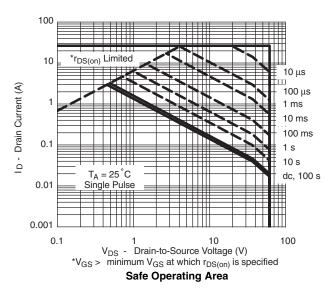


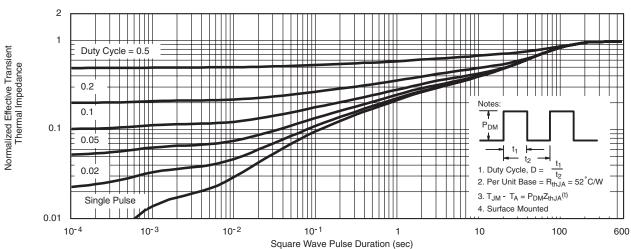
TYPICAL CHARACTERISTICS 25 °C, unless noted





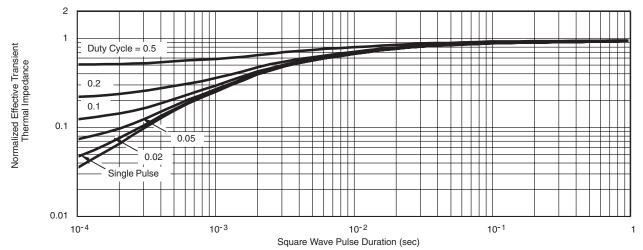
Single Pulse Power, Junction-to-Ambient





Normalized Thermal Transient Impedance, Junction-to-Ambient

TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73113.



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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com